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Docket No.: 075905-0037

103416873

To the Director of the U. S. Patent and Trademark Office, please record the attached documents or the new address(es) below.

1. Name of Conveying Party(ies)

Satoshi TAKAHASHI, Takashi IRIE

2. Name and address of receiving party(ies)

Name: HITACHI HIGH-TECHNOLOGIES
CORPORATION

Internal Address:

Address: 1-24-14, Nishi Shinbashi, Minato-ku,
Tokyo, Japan

Additional name(s) of conveying party(ies) attached? ☐ Yes ☐ No

Additional name(s) & address(es) attached? ☐ Yes ☐ No

3. Nature of Conveyance/Execution Date(s)

Execution Date(s): May 15, 2007

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Joint Research Agreement
☐ Government Interest Assignment
☐ Executive Order 9424, Confirmatory License
☐ Other

☒ This document is being filed together with a new application

B. Patent No(s).

4. Application or patent number(s):

A. Patent Application No(s).

Additional numbers attached? ☐ Yes ☐ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: MCDERMOTT WILL & EMERY LLP

Internal Address:

Street Address: 600 13th Street, N.W.

City: Washington State: D. C. Zip: 20005-3096

Phone Number: 202.756.8000

Fax Number: 202.756.8087

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6. Total number of applications and patents involved:

7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00

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9. Signature.

Keith E. George, 34,111

May 31, 2007

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Signature

Date

Total number of pages including cover sheet, attachments and documents: 2

OMB No. 0651-0027 (exp. 6/30/2008)

PATENT
REEL: 019442 FRAME: 0687

5.31.07

06/13/2007 DBYRNE 00000050 500417 11806318

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ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 1-24-14, Nishi Shinbashi, Minato-ku, Tokyo, Japan

receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

FLUORESCENCE ANALYZING METHOD, FLUORESCENCE ANALYZING APPARATUS AND IMAGE DETECTING METHOD

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) <u>Satoshi Takahashi</u>	<u>5/15/2007</u>
2) <u>Takashi Irie</u>	<u>5/15/2007</u>
3) _____	_____
4) _____	_____
5) _____	_____
6) _____	_____
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PATENT

RECORDED: 05/31/2007

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